EVM User's Guide: BP-CC3351 SimpleLink CC3351 Dual-Band Wi-Fi 6 and Bluetooth Low Energy BoosterPack Plug-in Module

Description

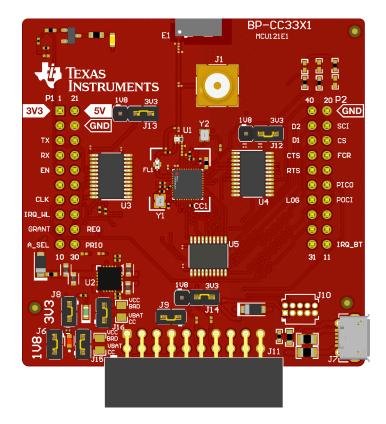
The SimpleLink[™] CC3351 Dual-Band Wi-Fi 6[®] and Bluetooth[®] low energy devices enable affordable, reliable and secure connectivity in embedded applications with a processor host running Linux[®] or an MCU host running RTOS. The CC3351 BoosterPack[™] plug-in module (BP-CC3351) is a test and development board that can be easily connected to TI LaunchPad[™] development kits or processor boards; thus enabling rapid software development. Note: The IC on this hardware is pre-production and thus does not have the finalized *CC3351* marking.

Features

 CC3351 Dual-band Wi-Fi 6 and Bluetooth low energy combo device



- Two 20-pin stackable connectors (BoosterPack standard)
- · Onboard chip dual-band antenna
- SMA/U.FL connector for conducted RF testing
- Power from on board dual rail (3.3V and 1.8V) LDO using USB or LaunchPad
- 3 level shifters for voltage translation (3.3V to 1.8V)
- JTAG header pins for SWD interface with XDS110 or LP-XDS110
- Jumper for current measurement on both power supplies (3.3V and 1.8V) with provision to mount 0.1 ohm (0603) resistors for measurement with voltmeter
- 32kHz oscillator for lower power evaluation



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1 Evaluation Module Overview

1.1 Introduction

The CC3351 BoosterPack plug-in module (BP-CC3351) is a test and development board that can easily be connected to TI LaunchPad or processor boards; thus enabling rapid software development.

This user's guide is intended to explain the various hardware configurations and features of the BP-CC3351. For more information about the CC3351 device, please refer to ti.com CC3351 product page.

1.2 Kit Contents

• BP-CC3351 PCBA

1.3 Specification

The BP-CC3351 is a board designed to enable rapid and easy software and hardware development for the CC3351 device. The block diagram for the BP-CC3351 is shown in Figure 1-1.

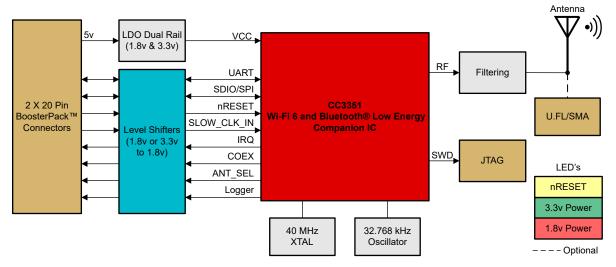


Figure 1-1. BP-CC3351 Block Diagram

This kit can be used in three configurations:

- 1. MCU and RTOS evaluation: BP-CC3351 + LaunchPad with the MCU running TCP/IP like the LP-AM243.
- 2. Processor and Linux evaluation: BP-CC3351 + BP-CC33-BBB-ADAPT + BEAGL-BONE-BLACK.
- 3. RF-testing with PC tools: BP-CC3351 + LP-XDS110.

In addition, the BP-CC3351 can also be wired to any other Linux or RTOS host board running TCP/IP stack.

Refer to Section 3.1 for more information.

1.4 Device Information

The purpose of the BP-CC3351 is to showcase the hardware and software capabilities of the CC3351 device. The other components on the board are populated for testing and support of this main device.



2 Hardware

Figure 2-1 shows the overview of the BP-CC3351.

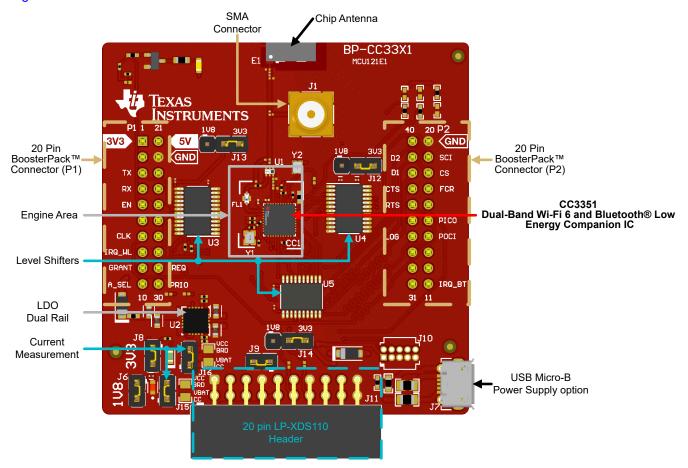


Figure 2-1. BP-CC3351 Overview

2.1 Hardware Features

- CC3351 Wi-Fi[®] 6 and Bluetooth[®] low energy combo device which can interface with MPU or MCU systems; adding connectivity
- Two 20-pin stackable connectors (BoosterPack[™] standard)
- · On-board chip dual-band antenna with on-board SMA/U.FL connector for conducted RF testing
- Power from on board dual rail (3.3V and 1.8V) LDO using USB or LaunchPad™
- 3 level shifters for voltage translation (3.3V to 1.8V)
- JTAG header pins for SWD interface with XDS110 or LP-XDS110
- Jumper for current measurement on both power supplies (3.3V and 1.8V) with provision to mount 0.1 ohm (0603) resistors for measurement with voltmeter
- 32kHz oscillator for lower power evaluation

2.2 Connector and Jumper Descriptions 2.2.1 LED Indicators

Table 2-1 lists the LED descriptions.

Table 2-1. LEDs				
Reference	Color	Usage	Comments	
D4	Green	3.3V power indication	On: 3.3V power rail is up. Off: no 3.3V power supplied.	
D6	Red	1.8V power indication	On: 1.8V power rail is up. Off: no 1.8V power supplied.	
D5	Yellow	nRESET	The LED indicates the state of the nReset pin. If that LED is on, the device is functional which means the nReset is high.	

Figure 2-2 shows the mentioned LEDs on the board.

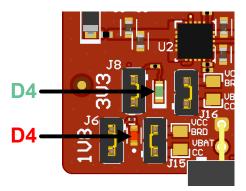


Figure 2-2. LEDs D4 & D5

2.2.2 Jumper Settings

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Table 2-2 lists the jumper settings. To reference the default jumper configurations, see Figure 2-1.

Reference	Usage	Comments
J1, J2	RF test	SMA connector (J1) or U.FL connector (J2) for conducted testing in the lab. See Section 2.5.
J6, J8	Power to board	Used to enable power to board for both supplies. See Section 2.3.
J15, J16	Current measurement	Used to measure power to device only. See Section 2.3.1.
J7	USB connector	For powering the BoosterPack standalone (not connected to LaunchPad).
J10,J11	JTAG connectors	Headers to interface with XDS110 debug probe. See Section 2.2.4.
J9	20-pin header (J11) 5V power	Enables 5V power supply to come from LP-XDS110.
J12, J13, J14	Level shifter host voltage	Set to 3.3V or 1.8V to enable relevant level shifters to translate to correct host voltage level.
P1, P2	BoosterPack header	2 X 20 pins each connected to LaunchPad. See Section 2.2.3.

Table 2-2. Jumper Settings

2.2.3 BoosterPack Header Assignment

The CC3351 BoosterPack has 2 x 20 pin connectors that provide access to many of the CC3351 pins and features. The signal assignment on these 2x20 pin connectors is shown in the figure below and described in Table 2-3 and Table 2-4.

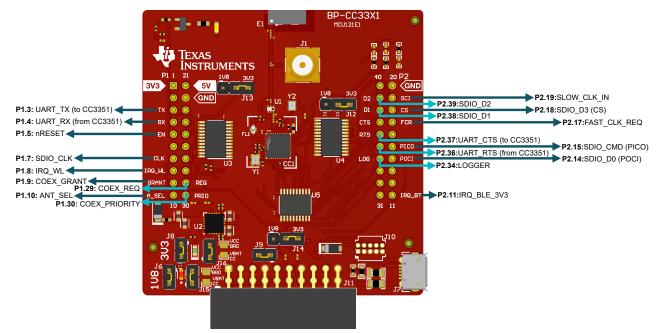


Figure 2-3. BP-CC3351 BoosterPack Header Pinout

Table 2-3. P1 Header Pin Assignment				
Pin	Name (in schematic)	Type/ Direction	Description	
P1.1	VCC_MCU_3V3	Input	No functional purpose.	
P1.2	Reserved	N/A	N/A	
P1.3	UART_TX_3V3 (from CC3351)	Output	The CC3351 UART TX to host for BLE host controller interface.	
P1.4	UART_RX_3V3 (to CC3351)	Input	The CC3351 UART RX from host for BLE host controller interface.	
P1.5	LP_RESET	Input	Reset line for CC3351 used to enable/ disable (active low). Driven by host through LaunchPad pins.	
P1.6	Reserved	N/A	N/A	
P1.7	SDIO_CLK_3V3	Input	SDIO clock or SPI clock. Must be driven by host.	
P1.8	IRQ_WL_3V3	Output	Interrupt request from CC3351 to host for Wi-Fi activity.	
P1.9	COEX_GRANT_3V3	Output	External coexistence interface - grant (reserved for future use).	
P1.10	ANT_SEL_3V3	Output	Antenna select control.	
P1.21	VCC_MCU_5V	Power	5V supply to board.	
P1.22	GND	GND	Board ground	
P1.23	Reserved	N/A	N/A	
P1.24	Reserved	N/A	N/A	
P1.25	Reserved	N/A	N/A	
P1.26	Reserved	N/A	N/A	
P1.27	Reserved	N/A	N/A	
P1.28	Reserved	N/A	N/A	

able 2-3.	P1	Header	Pin	Assign	ment
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Table 2-3. P1 Header Pin Assignment (continued)

Pin	Name (in schematic)	Type/ Direction	Description	
P1.29	COEX_REQ_3V3	Input	External coexistence interface - request (reserved for future use).	
P1.30	COEX_PRIORITY_3V3	Input	External coexistence interface - priority (reserved for future use).	

Table 2-4. P2 Header Pin Assignment

Pin	Name (in schematic)	Type/Direction	Description
P2.11	IRQ_BLE_3V3	Output	Interrupt request from CC3351 to host for BLE activity.
P2.12	Reserved	N/A	N/A
P2.13	Reserved	N/A	N/A
P2.14	SDIO_D0_3V3 (POCI)	Input/Output	SDIO data D0 or SPI POCI.
P2.15	SDIO_CMD_3V3 (PICO)	Input/Output	SDIO command or SPI PICO.
P2.16	Reserved	N/A	N/A
P2.17	FAST_CLK_REQ_3V3	Output	Fast clock request from CC3351 to host.
P2.18	SDIO_D3_3V3 (CS)	Input/Output	SDIO data D3 or SPI CS.
P2.19	SLOW_CLK_IN_3V3	Input	Input for external RTC clock 32.768kHz.
P2.20	GND	GND	Board ground
P2.31	Reserved	N/A	N/A
P2.32	Reserved	N/A	N/A
P2.33	Reserved	N/A	N/A
P2.34	LOGGER_3V3	Output	Tracer from CC3351 (UART TX debug logger).
P2.35	Reserved	N/A	N/A
P2.36	UART_RTS_3V3 (from CC3351)	Output	UART RTS from CC3351 to host for BLE HCI flow control.
P2.37	UART_CTS_3V3 (to CC3351)	Input	UART CTS to CC3351 from host for BLE HCI flow control.
P2.38	SDIO_D1_3V3	Input/Output	SDIO data D1.
P2.39	SDIO_D2_3V3	Input/Output	SDIO data D2.
P2.40	Reserved	N/A	N/A



2.2.4 JTAG Headers

The BP-CC3351 was designed with 2 JTAG headers (J10, J11) for SWD interface with the XDS110 debug probe. The signal assignment for these headers are described in the figures and tables below.

The main JTAG interface for the BP-CC3351 is via the LP-XDS110 (ET) that is connected to the 20pin header (J11). A XDS110 debug probe can also interface with this board via a 10-pin header (J10), however this header is not populated with the default kit.

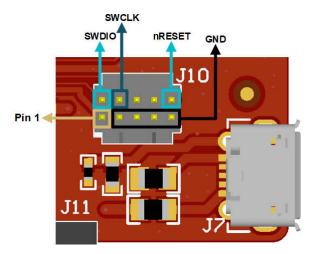


Figure 2-4. ARM 10 pin JTAG Connector (J10)

Table 2-5. ARM 10 pin JTAG Connector (J10) Assignment

Pin	Signal Name	Description	
J10.1	VCC_BRD_1V8	1.8V supply for reference voltage to connector	
J10.2	SWDIO	Serial wire data in/out	
J10.4	SWCLK	Serial wire clock	
J10.10	RESET_1V8	nReset (Enable line for CC3351)	
J10.3, J10.5, J10.7, J10.9	GND	Board ground	

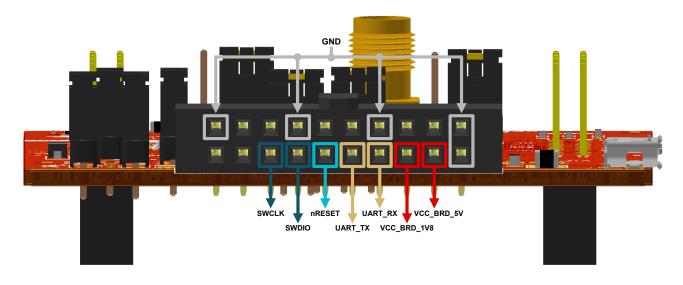


Figure 2-5. 20 pin LP-XDS110 Connector (J11)

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Table 2-6. 20 Pin LP-XDS110 Connector (J11) Assignment				
Pin	Signal Name	Description		
J11.6	SWCLK	Serial wire clock		
J11.8	SWDIO	Serial wire data in/out		
J11.10	RESET_1V8	nReset (Enable line for the CC3351)		
J11.12	UART_TX_1V8	The CC3351 UART TX to host for BLE host controller interface		
J11.14	UART_RX_1V8	The CC3351 UART RX from host for BLE host controller interface		
J11.16	VCC_BRD_1V8	1.8V supply for reference voltage to connector		
J11.18	VCC_BRD_5V	5V supply to BP-CC3351 from LP-XDS110		
J11.1, J11.7, J11.13, J11.19, J11.20	GND	Board ground		

Table 2-6. 20 Pin LP-XDS110 Connector (J11) Assignment

2.3 Power

The board is designed to accept power from a connected LaunchPad kit. Some LaunchPad kits cannot source the peak current requirements for Wi-Fi, which can be as high as 500mA. In such cases, the USB connector (J7) on the BP-CC3351 can be used to aid in extra current. The use of Schottky diodes make sure that load sharing occurs between the USB connectors on the LaunchPad kit and the BoosterPack module without any board modifications. The jumpers labeled J6 (1.8V) and J8 (3.3V) can be used to measure the total current consumption of the board from the onboard LDO.

2.3.1 Measure the CC3351 Current Draw

2.3.1.1 Low Current Measurement (LPDS)

To measure the current draw of the CC3351 device for both power supplies (3.3V or 1.8V), a jumper labeled J16 (for 3.3V supply) and a jumper labeled J15 (for 1.8V supply) is provided on the board. By removing J16, users can place an ammeter into this path to observe the current on the 3.3V supply. The same process can be used for observing the current on the 1.8V supply with J15. TI recommends this method for measuring the LPDS.

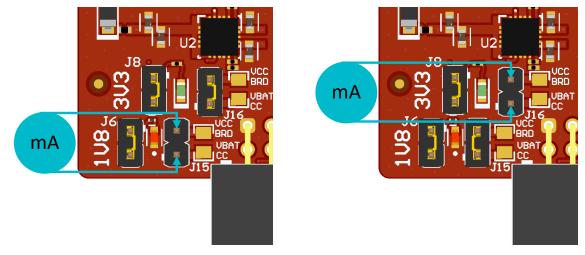


Figure 2-6. Low Current Measurement

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2.3.1.2 Active Current Measurement

To measure active current in a profile form, TI recommends using a 0.1Ω 1% 0603 resistor on the board, and measuring the differential voltage across the resistor. This can be done using a voltmeter or an oscilloscope for measuring the current profile for both power supplies (3.3V or 1.8V).

Jumper J15 shunt is removed and a 0.01 resistor is populated in parallel to measure the active currents on the 1.8V supply (see Figure 2-8). Similar operation with J16 and 3.3V supply.

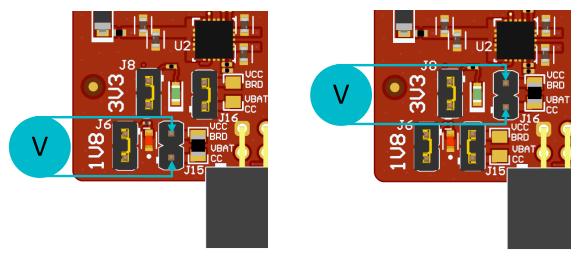


Figure 2-7. Active Current Measurement

2.4 Clocking

The BP-CC3351 provides two clock inputs to the CC3351 device:

- Y1 is a 40MHz crystal for fast clock input.
- Y2 is a 32.768kHz oscillator for slow clock input.

If the user desires to provide the own external slow clock through the Slow Clock Input pin (P2.19), then some re-work must be performed. The Y2 oscillator needs to be removed, and populate a 0201 sized, 0 ohm resistor on R29 pad. See Figure 2-8. The slow clock can also be generated internally to save on BOM.

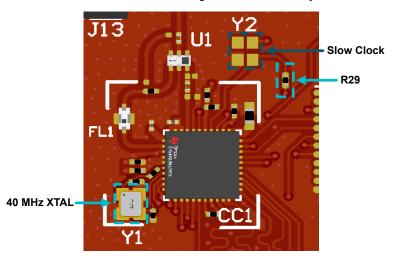


Figure 2-8. BP-CC3351 Clock Circuitry



2.5 Performing Conducted Testing

As seen in Figure 2-9, the BP-CC3351 has an on-board SMA connector and component antenna. The SMA connector (J1) provides a way for testing conducted measurements. Alternately, a track pad for a U.FL connector (J2) is provided on-board to replace the SMA connector and provide a way to test in the lab using a compatible cable (see Figure 2-9).

A rework is needed before using the connector on J1/J2. This involves swapping the position of the existing 3.9pF capacitor to lead the transmission line on the desired connection (see Figure 2-9).

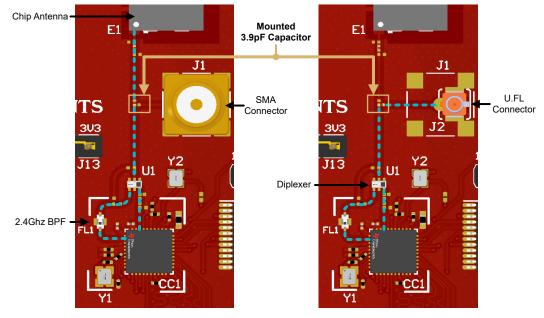


Figure 2-9. RF Path on BP-CC3351



3 Implementation Results

3.1 Evaluation Setups

The CC3351 BoosterPack can be used in the following configurations:

- MCU and RTOS evaluation: BP-CC3351 + LaunchPad with the MCU running TCP/IP like the LP-AM243
- Processor and Linux evaluation: BP-CC3351 + BP-CC33-BBB-ADAPT + BEAGL-BONE-BLACK
- RF testing with PC tools: BP-CC3351 + LP-XDS110

In addition, the BP-CC3351 can also be wired to any other Linux or RTOS host board running TCP/IP stack.

3.1.1 MCU and RTOS

The BP-CC3351 can be used with a MCU running TCP/IP, like the LP-AM243 and can easily integrate with the LaunchPad by stacking the 40 pin headers, as shown in Figure 3-1.

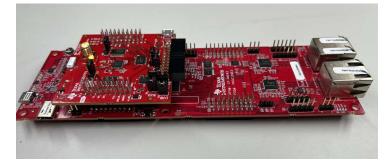


Figure 3-1. BP-CC3351 with LP-AM243

3.1.2 Processor and Linux

The BP-CC3351 can integrate with a host platform running Linux OS, like the BeagleBoard.org[®] BeagleBone[®] Black (BBB). The BeagleBone Black is a low-cost, community-supported development platform as shown below.



Figure 3-2. BeagleBone Black Board



To interface with the BP-CC3301 with the BeagleBone Black, the user also needs the BP-CC33xx to BBB Adapter Board (SPAU022).

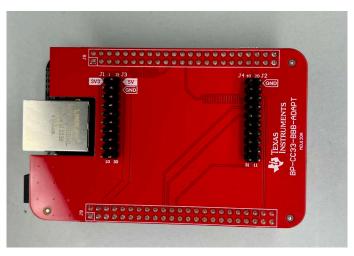


Figure 3-3. Adapter Board for the BeagleBone Black

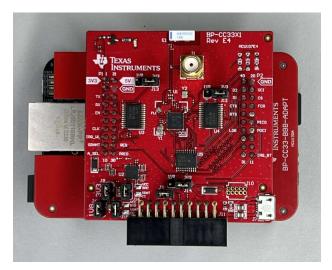


Figure 3-4. BP-CC3351 + BBB with Adapter Board

To make sure the BeagleBone Black boots up from the SD card, TI recommends to add a 100k Ohm resistor for R93 on the top of the BBB, and remove the R68 resistor seen on the bottom of the BBB. Alternatively, you can press and hold the S2 button on the BeagleBone board during power up if the hardware modifications were not made. (See Figure 3-5 and Figure 3-6).

Lastly, adding a right angle header on the bottom of the BBB to easily connect the FTDI cable is optional. When the adapter board is attached to the BBB, the FTDI cable can get pinched between the BBB and adapter board, which can cause communication problems. (see Figure 3-6).



R93 place 100k ohm



Figure 3-5. Top View of Modified BBB

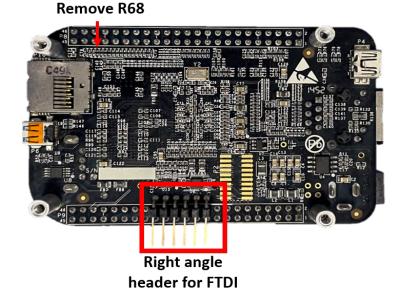


Figure 3-6. Bottom View of Modified BBB

3.1.3 Standalone RF Testing

The BP-CC3351 can be used standalone (without a host) to test RF capabilities, using Radio Tool. For more information on Radio Tool and where to download, refer to Wi-Fi Toolbox BP-CC3301 Hardware Setup.

The BP-CC3351 has an on-board SMA connector and component antenna, and a U.FL can be populated on the board, for conducted RF testing using compatible cables (a rework can be needed). For more information, see Section 2.5.

3.1.3.1 Radio Tool BP-CC3301 Hardware Setup

Radio Tool is a GUI-based tool for RF evaluation and testing of CC33xx designs during development and certification. The tool enables low-level radio testing capabilities by manually setting the radio into transmit or receive modes. Usage of the tool requires familiarity and knowledge of radio circuit theory and radio test methods. To preform conducted RF testing on the BP-CC3351, refer to Section 2.5. Note that a rework can be needed.

The user can download this tool from the CC330x product page on ti.com.

Submit Document Feedback



HW Prerequisites

- Windows 10 64bit/ Ubuntu 18 (or higher) 64bit operation system
- Latest Chrome web browser
- Installation of Simplelink Wi-Fi Toolbox
- BP-CC3351
- LP-XDS110 debugger for SWD communication

The LP-XDS110 enables direct communication to the CC3351 device via the SWD interface. This allows external tools, such as the Radio Tool, to send commands directly to the device without the use of an embedded host.

Testing with LP-XDS110

To use the LP-XDS110 with the BP-CC3351, connect the 20-pin LP-XDS110 connector (J11) on the BP-CC3351 to the corresponding connector on the LP-XDS110 (see Figure 3-7). Make sure that the jumper on the LP-XDS110 (labeled TGT VDD) is in the EXT. configuration, as shown in Figure 3-7. This verifies that the target voltage for the JTAG signals are sourced from the BP-CC3351 (which is 1.8V) instead of the default LP-XDS110 target voltage (3.3V).

Power supply for the BP-CC3351 comes from the LP-XDS110 in this case, but there can be usage scenarios where additional current is needed from the USB connection (J7).

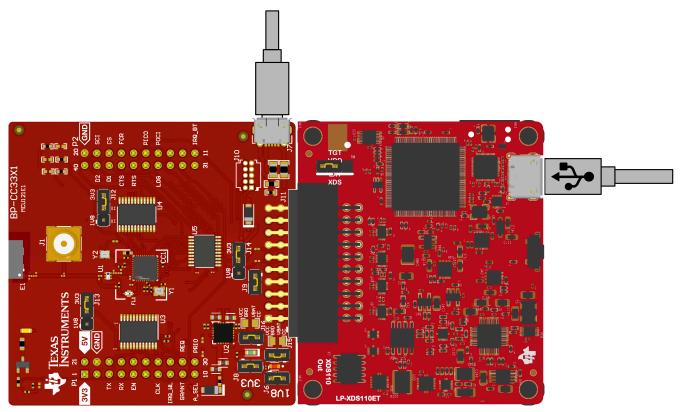


Figure 3-7. BP-CC3351 Connected to LP-XDS110 (ET)



4 Hardware Design Files

4.1 Schematics

To access the schematics for the BP-CC3351, the user can submit a request on the ti.com CC3351 tool folder under Request more information section. Request Now.

4.2 PCB Layouts

To access the Gerber files for the BP-CC3351, the user can submit a request on the ti.com CC3351 tool folder under Request more information section. Request Now.

4.3 Bill of Materials (BOM)

To access the BOM list for the BP-CC3351, the user can submit a request on the ti.com CC3351 tool folder under Request more information section. Request Now.

5 Additional Information

5.1 Trademarks

SimpleLink[™], BoosterPack[™], LaunchPad[™] are trademarks of Texas Instruments.

Wi-Fi 6® and Wi-Fi® are registered trademarks of Wi-Fi Alliance.

Bluetooth[®] is a registered trademark of Bluetooth Sig, Inc.

Linux[®] is a registered trademark of Linux Foundation.

BeagleBoard.org® and BeagleBone® are registered trademarks of BeagleBoard.org Foundation.

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 - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGREDATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.
- 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

- 3.3 Japan
 - 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に 輸入される評価用キット、ボードについては、次のところをご覧ください。

https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html

3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

【無線電波を送信する製品の開発キットをお使いになる際の注意事項】 開発キットの中には技術基準適合証明を受けて

いないものがあります。 技術適合証明を受けていないもののご使用に際しては、電波法遵守のため、以下のいずれかの 措置を取っていただく必要がありますのでご注意ください。

- 1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用 いただく。
- 2. 実験局の免許を取得後ご使用いただく。
- 3. 技術基準適合証明を取得後ご使用いただく。
- なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。 上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。 日本テキサス・イ

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東京都新宿区西新宿6丁目24番1号

西新宿三井ビル

- 3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧くださ い。https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html
- 3.4 European Union
 - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

4 EVM Use Restrictions and Warnings:

- 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
- 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
- 4.3 Safety-Related Warnings and Restrictions:
 - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
 - 4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and inability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.
- 4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.
- 5. Accuracy of Information: To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.
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 - 6.1 EXCEPT AS SET FORTH ABOVE, EVMS AND ANY MATERIALS PROVIDED WITH THE EVM (INCLUDING, BUT NOT LIMITED TO, REFERENCE DESIGNS AND THE DESIGN OF THE EVM ITSELF) ARE PROVIDED "AS IS" AND "WITH ALL FAULTS." TI DISCLAIMS ALL OTHER WARRANTIES, EXPRESS OR IMPLIED, REGARDING SUCH ITEMS, INCLUDING BUT NOT LIMITED TO ANY EPIDEMIC FAILURE WARRANTY OR IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF ANY THIRD PARTY PATENTS, COPYRIGHTS, TRADE SECRETS OR OTHER INTELLECTUAL PROPERTY RIGHTS.
 - 6.2 EXCEPT FOR THE LIMITED RIGHT TO USE THE EVM SET FORTH HEREIN, NOTHING IN THESE TERMS SHALL BE CONSTRUED AS GRANTING OR CONFERRING ANY RIGHTS BY LICENSE, PATENT, OR ANY OTHER INDUSTRIAL OR INTELLECTUAL PROPERTY RIGHT OF TI, ITS SUPPLIERS/LICENSORS OR ANY OTHER THIRD PARTY, TO USE THE EVM IN ANY FINISHED END-USER OR READY-TO-USE FINAL PRODUCT, OR FOR ANY INVENTION, DISCOVERY OR IMPROVEMENT, REGARDLESS OF WHEN MADE, CONCEIVED OR ACQUIRED.
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- 8. Limitations on Damages and Liability:
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 - 8.2 Specific Limitations. IN NO EVENT SHALL TI'S AGGREGATE LIABILITY FROM ANY USE OF AN EVM PROVIDED HEREUNDER, INCLUDING FROM ANY WARRANTY, INDEMITY OR OTHER OBLIGATION ARISING OUT OF OR IN CONNECTION WITH THESE TERMS, EXCEED THE TOTAL AMOUNT PAID TO TI BY USER FOR THE PARTICULAR EVM(S) AT ISSUE DURING THE PRIOR TWELVE (12) MONTHS WITH RESPECT TO WHICH LOSSES OR DAMAGES ARE CLAIMED. THE EXISTENCE OF MORE THAN ONE CLAIM SHALL NOT ENLARGE OR EXTEND THIS LIMIT.
- 9. Return Policy. Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.
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